

E

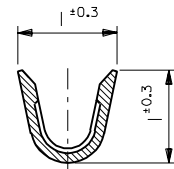
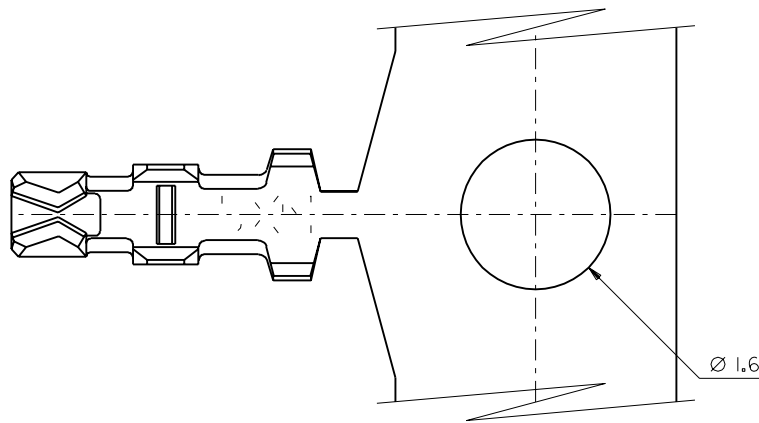
D

C
DIMENSIONS IN METRIC DO NOT SCALE DRAWING

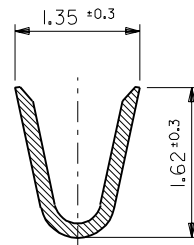
B

A

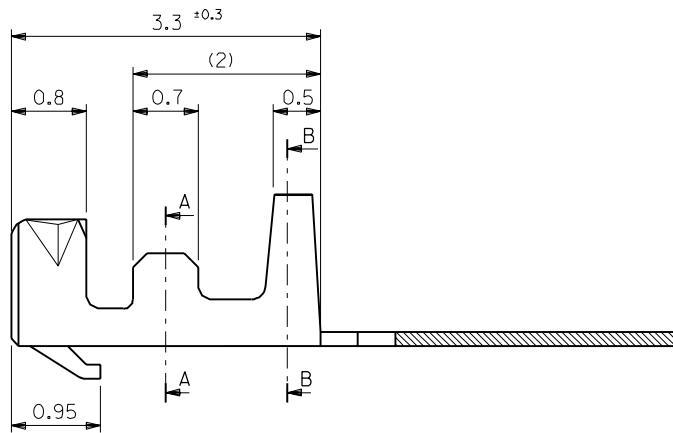
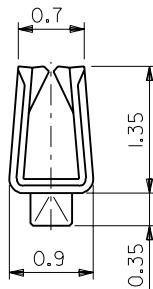
MM



SECT. A-A



SECT. B-B



50058-8100	バラ状 LOOSE
50058-8000	連鎖状 CHAIN
ENG. NO.	端子形状 FORM

注記
NOTES

- 適合ハウジング：51021シリーズ
APPLICABLE HOUSING：51021 SERIES
- メッキ仕様 PLATING
錫 0.9μm MIN. リフロー処理（前メッキ）
TIN 0.9μm MIN. REFLOW TREATMENT (PRE-PLATED)

角度 ANGLE	±3°					材料 MATERIAL リン青銅 PHOSPHOR BRONZE (t=0.15)
30以上 OVER	+0.3					仕上げ FINISH —H—
10以上 30未満 OVER UNDER	+0.25	D	変更 REVISED (J30883)	H.H. M.F.	'93/9/3	適用電線範囲 WIRE RANGE AWG #28-32
10未満 UNDER	+0.2	C	変更&再作図 REVISED & REDRAWN (J20810)	H.H. M.F.	'92/10/27	被覆外径 INS. RANGE $\varnothing 0.5-1.0$
一般公差 GENERAL TOLERANCES	記号 LTR	変更内容 REVISION RECORD	DR. CHK.	日付 DATE	APP'D BY M.FUKUSHIMA	CHK'D BY M.FUKUSHIMA
					93/9/3	尺度 SCALE 20 - 1

molex MOLEX-JAPAN CO.,LTD.
日本モレックス株式会社

REVISE ONLY ON CAD SYSTEM
TITLE 名称
1.25 WIRE TO BOARD CONN.
CRIMP REC. TERMINAL

DWG. NO. SD-50058-8*00
REV D